

L Number	Hits	Search Text	DB	Time stamp
1	4	((("4098945") or ("5104580")).PN.	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 17:56
2	105	(PCB or board or substrate) and (metal adj core) and cladding	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 17:57
3	41	(PCB or board or substrate) and (metal adj core) and cladding and carbon	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:06
4	53557	(PCB or (printed adj circuit adj board)) and ((metal adj core) or conductors or pattern)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:08
5	0	(PCB or (printed adj circuit adj board)) and ((metal adj core) or conductors or pattern) and (carbon near3 cladding)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:09
6	391	carbon near3 cladding	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:09
7	299	(carbon near3 cladding) and (metal core)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:14
8	69	((carbon near3 cladding) and (metal core)) and (board or substrate)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:16
9	11599	333/\$.ccls. and (PCB or board or substrate)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:26
10	5223	(333/\$.ccls. and (PCB or board or substrate)) and transmission	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:17
11	74	((333/\$.ccls. and (PCB or board or substrate)) and transmission) and cladding	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:17
12	0	333/\$.ccls. and (PCB or board or substrate) and (carbon near4 clad\$4)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:26
13	95	333/\$.ccls. and (PCB or board or substrate) and cladding	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:34
14	7	("5595937" "5956267" "6030877" "6174737" "6211090" "6261893" "6278165").PN.	USPAT	2004/10/27 18:27
15	2	("5956267" "6165803").PN.	USPAT	2004/10/27 18:31
16	6	(carbon near3 cladding) and (circuit adj board)	USPAT; EPO; JPO; DERWENT; USOCR	2004/10/27 18:34